





DUAL SURFACE MOUNT LOW LEAKAGE DIODE

Features

- Surface Mount Package Ideally Suited for Automated Insertion
- Very Low Leakage Current
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 1 and 2)
- Qualified to AEC-Q101 Standards for High Reliability

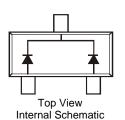
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)





Top View



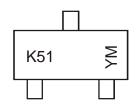
Ordering Information (Note 3)

| Part Number | Qualification | Case | Packaging |
|--------------|---------------|-------|--------------------|
| BAV170-7-F | Commercial | SOT23 | 3,000/Tape & Reel |
| BAV170-13-F | Commercial | SOT23 | 10,000/Tape & Reel |
| BAV170Q-7-F | Automotive | SOT23 | 3,000/Tape & Reel |
| BAV170Q-13-F | Automotive | SOT23 | 10.000/Tape & Reel |

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Product manufactured with Date Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



K51 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Kev

| Year | 2001 | 2002 | | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 | 2016 | 2017 |
|-------|------|------|-----|------|------|------|------|------|------|------|------|------|
| Code | М | N | | W | Х | Υ | Z | Α | В | С | D | Е |
| | | | | | | | | | | | | |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |



| Characteristic | Symbol | Value | Unit | |
|--|--|---|-------------------|----|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | | V _{RRM} V _R WM V _R | 85 | ٧ |
| RMS Reverse Voltage | | V _{R(RMS)} | 60 | V |
| Forward Continuous Current (Note 4) | Single Diode Double Diode | I _{FM} | 215 125 | mA |
| Repetitive Peak Forward Current | | I _{FRM} | 500 | mA |
| Non-Repetitive Peak Forward Surge Current | @ t = 1.0μs @ t = 1.0ms @ t = 1.0s | I _{FSM} | 4.0 1.0 0.5 | А |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------------------------|-------------|------|
| Power Dissipation (Note 4) | P_{D} | 250 | mW |
| Thermal Resistance Junction to Ambient Air (Note 4) | $R_{	hetaJA}$ | 500 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

Electrical Characteristics @TA = 25°C unless otherwise specified

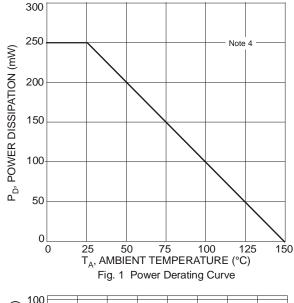
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|-----------------|-----|-----|----------------------------|----------|--|
| Reverse Breakdown Voltage (Note 5) | $V_{(BR)R}$ | 85 | _ | _ | V | $I_R = 100 \mu A$ |
| Forward Voltage | V _F | _ | _ | 0.90 1.0 1.1 1.25 | V | I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA |
| Leakage Current (Note 5) | I _R | _ | _ | 5.0 80 | nA nA | V _R = 75V V _R = 75V, T _J = 150°C |
| Total Capacitance | C _T | _ | 2 | _ | pF | $V_R = 0, f = 1.0MHz$ |
| Reverse Recovery Time | t _{rr} | _ | _ | 3.0 | μS | $I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$ |

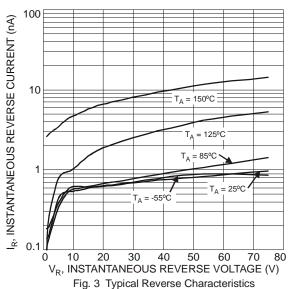
Notes:

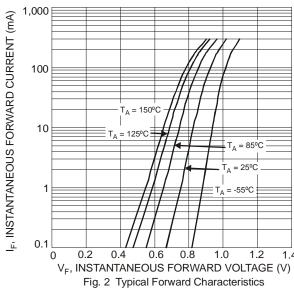
^{4.} Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.

^{5.} Short duration pulse test used to minimize self-heating effect.









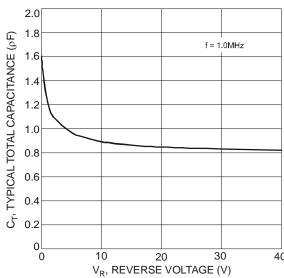
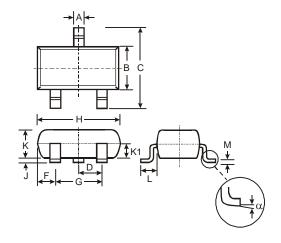


Fig. 4 Typical Capacitance vs. Reverse Voltage

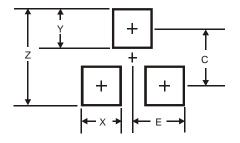
Package Outline Dimensions



| SOT23 | | | | | | | |
|----------------------|-------|------|-------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 0.37 | 0.51 | 0.40 | | | | |
| В | 1.20 | 1.40 | 1.30 | | | | |
| С | 2.30 | 2.50 | 2.40 | | | | |
| D | 0.89 | 1.03 | 0.915 | | | | |
| F | 0.45 | 0.60 | 0.535 | | | | |
| G | 1.78 | 2.05 | 1.83 | | | | |
| Н | 2.80 | 3.00 | 2.90 | | | | |
| J | 0.013 | 0.10 | 0.05 | | | | |
| K | 0.903 | 1.10 | 1.00 | | | | |
| K1 | - | - | 0.400 | | | | |
| L | 0.45 | 0.61 | 0.55 | | | | |
| М | 0.085 | 0.18 | 0.11 | | | | |
| α | 0° | 8° | - | | | | |
| All Dimensions in mm | | | | | | | |



Suggested Pad Layout



| Dimensions | Value (in mm) | | |
|------------|---------------|--|--|
| Z | 2.9 | | |
| Х | 0.8 | | |
| Υ | 0.9 | | |
| С | 2.0 | | |
| Е | 1.35 | | |

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